

NP20N10YDF

R07DS0705EJ0100

Rev.1.00

Apr 17, 2012

MOS FIELD EFFECT TRANSISTOR

Description

The NP20N10YDF is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

- Low on-state resistance
 $R_{DS(on)} = 55 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 10 \text{ A)}$
 $R_{DS(on)} = 68 \text{ m}\Omega \text{ MAX. (} V_{GS} = 5 \text{ V, } I_D = 10 \text{ A)}$
 $R_{DS(on)} = 74 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.5 \text{ V, } I_D = 10 \text{ A)}$
- Low C_{iss} : $C_{iss} = 1000 \text{ pF TYP. (} V_{DS} = 25 \text{ V, } V_{GS} = 0 \text{ V)}$
- Logic level drive type
- Designed for automotive application and AEC-Q101 qualified

Ordering Information

Part No.	Lead Plating	Packing		Package
NP20N10YDF-E1-AY *1	Pure Sn (Tin)	Tape 2500 p/reel	Taping (E1 type)	8-pin HSON
NP20N10YDF-E2-AY *1			Taping (E2 type)	

Note: *1 Pb-free (This product does not contain Pb in the external electrode)

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	100	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	V_{GSS}	± 20	V
Drain Current (DC) ($T_C = 25^\circ\text{C}$)	$I_{D(DC)}$	± 20	A
Drain Current (pulse) *1	$I_{D(pulse)}$	± 40	A
Total Power Dissipation ($T_C = 25^\circ\text{C}$)	P_{T1}	61	W
Total Power Dissipation ($T_A = 25^\circ\text{C}$) *2	P_{T2}	1.0	W
Channel Temperature	T_{ch}	175	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +175	$^\circ\text{C}$
Single Avalanche Current *3	I_{AS}	16	A
Single Avalanche Energy *3	E_{AS}	26	mJ

Thermal Resistance

Channel to Case Thermal Resistance $R_{th(ch-C)} = 2.46 \text{ }^\circ\text{C/W}$

Channel to Ambient Thermal Resistance *2 $R_{th(ch-A)} = 150 \text{ }^\circ\text{C/W}$

Notes: *1 $T_C = 25^\circ\text{C}$, $P_W \leq 10 \text{ }\mu\text{s}$, Duty Cycle $\leq 1\%$

*2 Mounted on glass epoxy substrate of 40 mm \times 40 mm \times 1.6 mm with 4% copper area (35 μm)

*3 $T_{ch(start)} = 25^\circ\text{C}$, $V_{DD} = 50 \text{ V}$, $R_G = 25 \text{ }\Omega$, $L = 100 \text{ }\mu\text{H}$, $V_{GS} = 20 \text{ V} \rightarrow 0 \text{ V}$

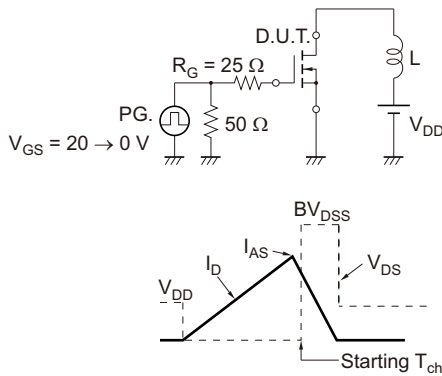
Caution: This product is an electrostatic-sensitive device due to low ESD capability and should be handled with caution for electrostatic discharge. HBM (C = 100 pF, R = 1.5 k Ω) $\pm 700 \text{ V}$.

Electrical Characteristics ($T_A = 25^\circ\text{C}$)

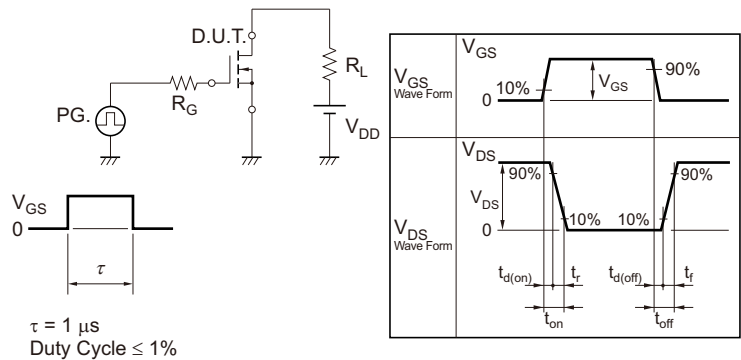
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I_{DSS}	—	—	1	μA	$V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}$
Gate Leakage Current	I_{GSS}	—	—	± 100	nA	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	1.5	2.0	2.5	V	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$
Forward Transfer Admittance *1	$ y_{fs} $	8	17	—	S	$V_{DS} = 5\text{ V}, I_D = 10\text{ A}$
Drain to Source On-state Resistance *1	$R_{DS(on)1}$	—	45	55	m Ω	$V_{GS} = 10\text{ V}, I_D = 10\text{ A}$
	$R_{DS(on)2}$	—	50	68	m Ω	$V_{GS} = 5\text{ V}, I_D = 10\text{ A}$
	$R_{DS(on)3}$	—	53	74	m Ω	$V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$
Input Capacitance	C_{iss}	—	1000	1500	pF	$V_{DS} = 25\text{ V}$ $V_{GS} = 0\text{ V}$ $f = 1\text{ MHz}$
Output Capacitance	C_{oss}	—	100	150	pF	
Reverse Transfer Capacitance	C_{rss}	—	50	90	pF	
Turn-on Delay Time	$t_{d(on)}$	—	13	26	ns	$V_{DD} = 50\text{ V}, I_D = 10\text{ A}$ $V_{GS} = 10\text{ V}$ $R_G = 0\ \Omega$
Rise Time	t_r	—	10	25	ns	
Turn-off Delay Time	$t_{d(off)}$	—	40	80	ns	
Fall Time	t_f	—	4	10	ns	
Total Gate Charge	Q_G	—	24	36	nC	$V_{DD} = 80\text{ V}$ $V_{GS} = 10\text{ V}$ $I_D = 20\text{ A}$
Gate to Source Charge	Q_{GS}	—	4	—	nC	
Gate to Drain Charge	Q_{GD}	—	7	—	nC	
Body Diode Forward Voltage *1	$V_{F(S-D)}$	—	0.92	1.5	V	$I_F = 20\text{ A}, V_{GS} = 0\text{ V}$
Reverse Recovery Time	t_{rr}	—	56	—	ns	$I_F = 20\text{ A}, V_{GS} = 0\text{ V}$
Reverse Recovery Charge	Q_{rr}	—	128	—	nC	$di/dt = 100\text{ A}/\mu\text{s}$

Note: *1 Pulsed test

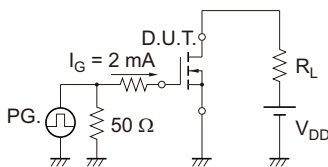
TEST CIRCUIT 1 AVALANCHE CAPABILITY



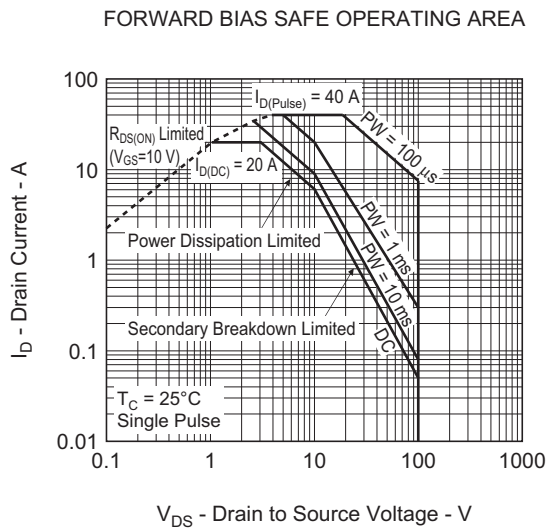
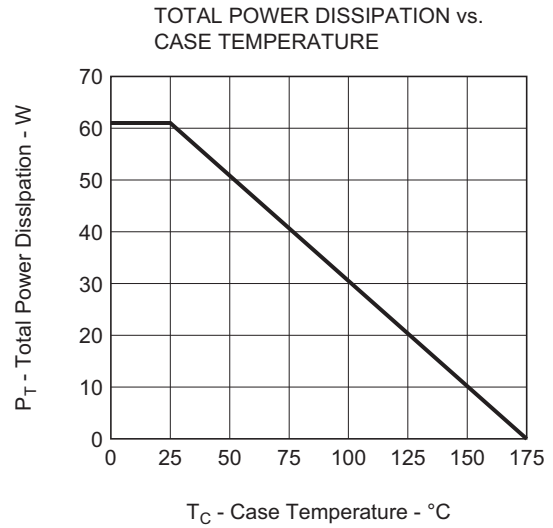
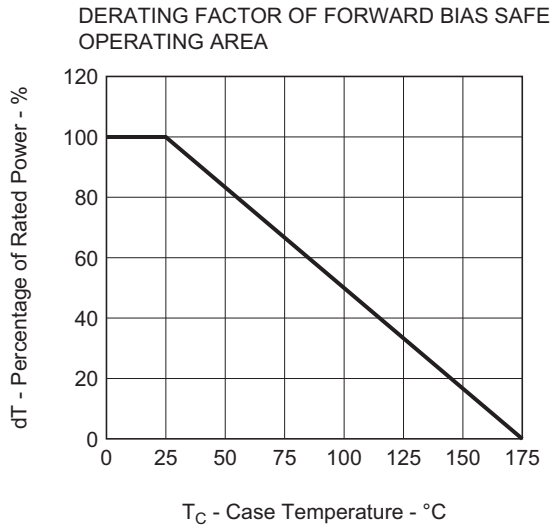
TEST CIRCUIT 2 SWITCHING TIME



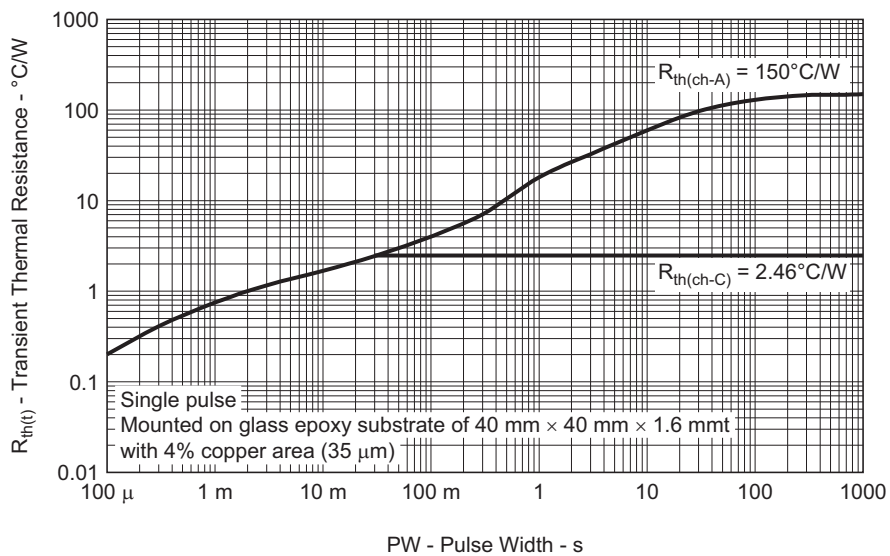
TEST CIRCUIT 3 GATE CHARGE

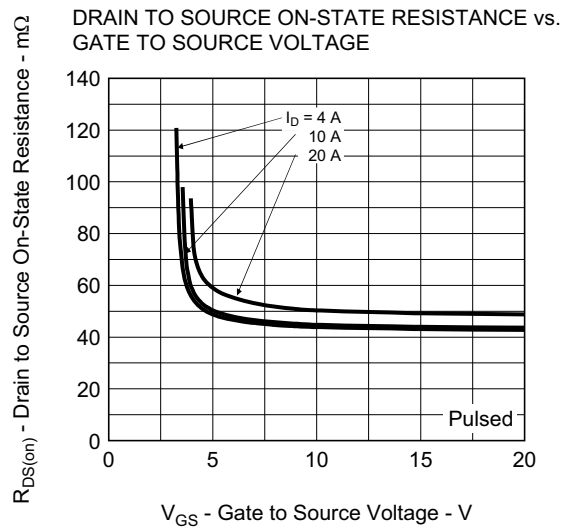
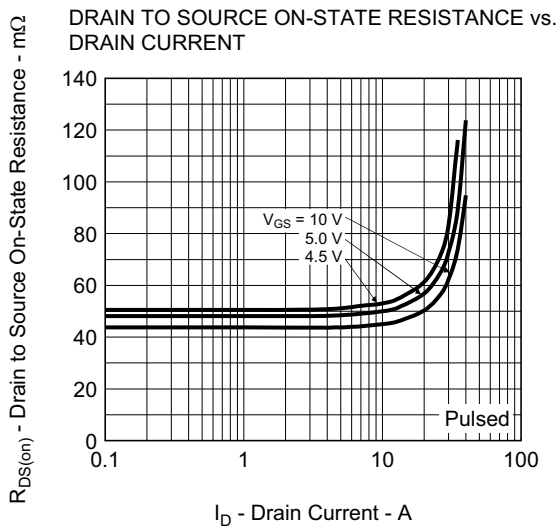
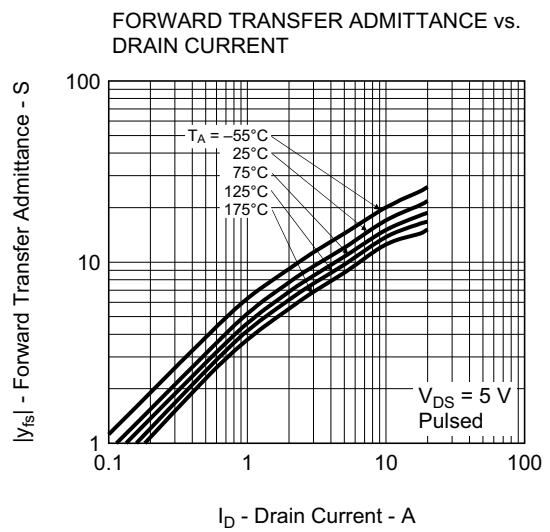
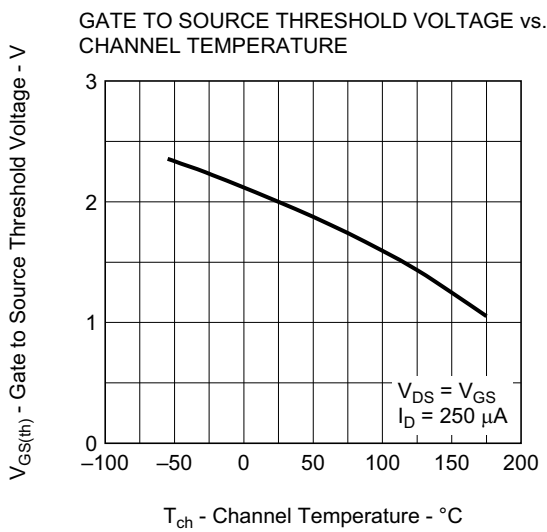
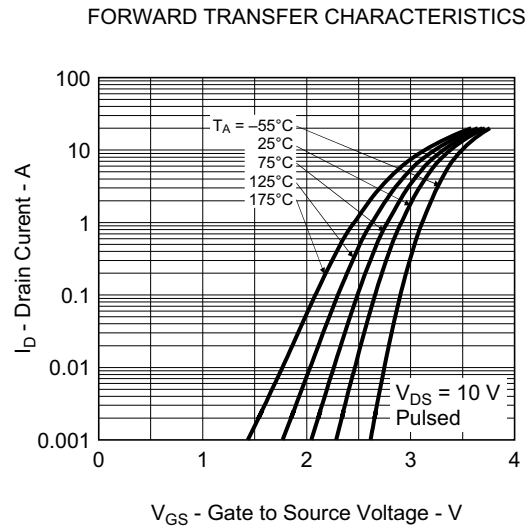
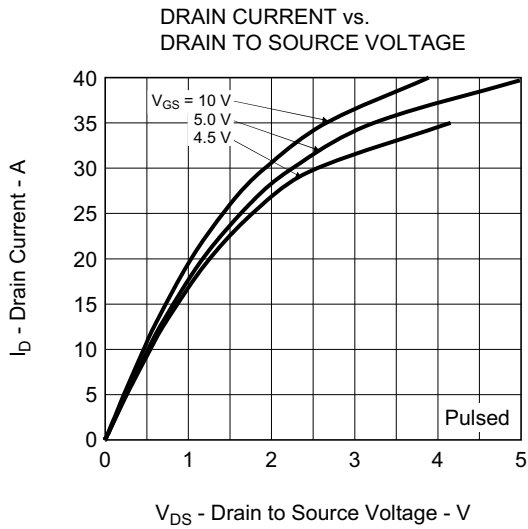


Typical Characteristics ($T_A = 25^\circ\text{C}$)

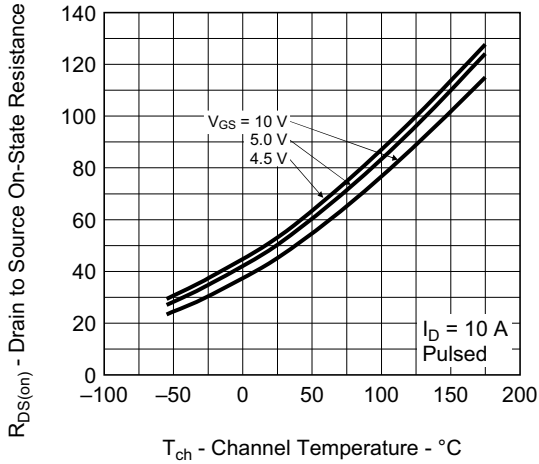


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

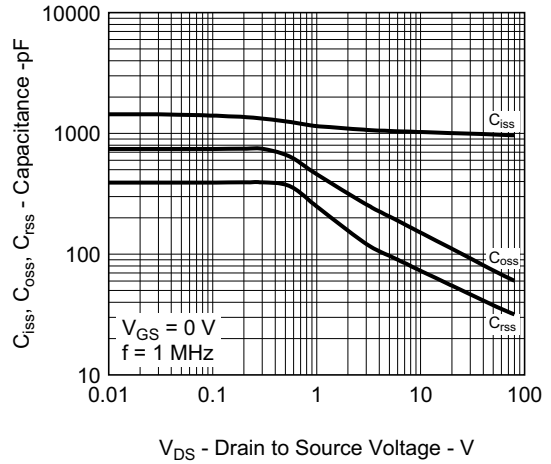




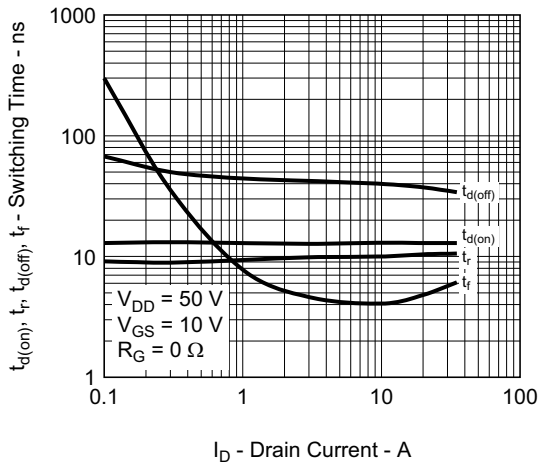
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



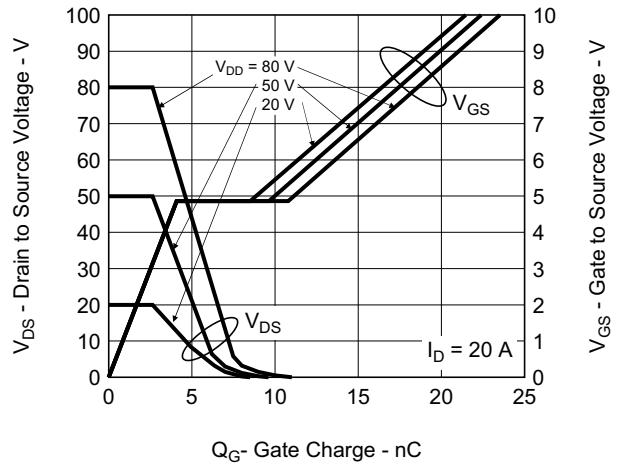
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



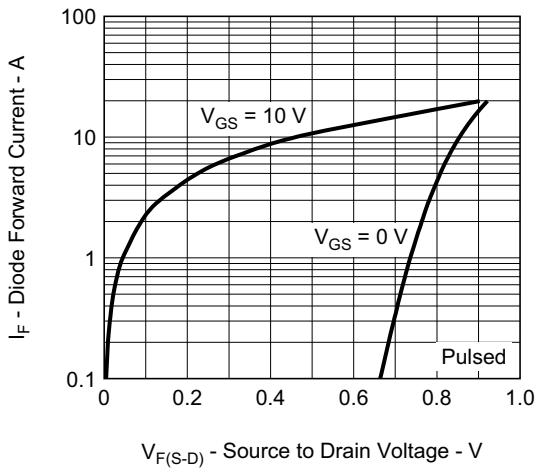
SWITCHING CHARACTERISTICS



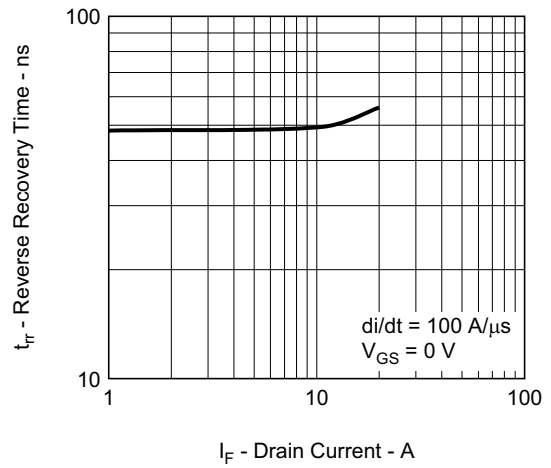
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE

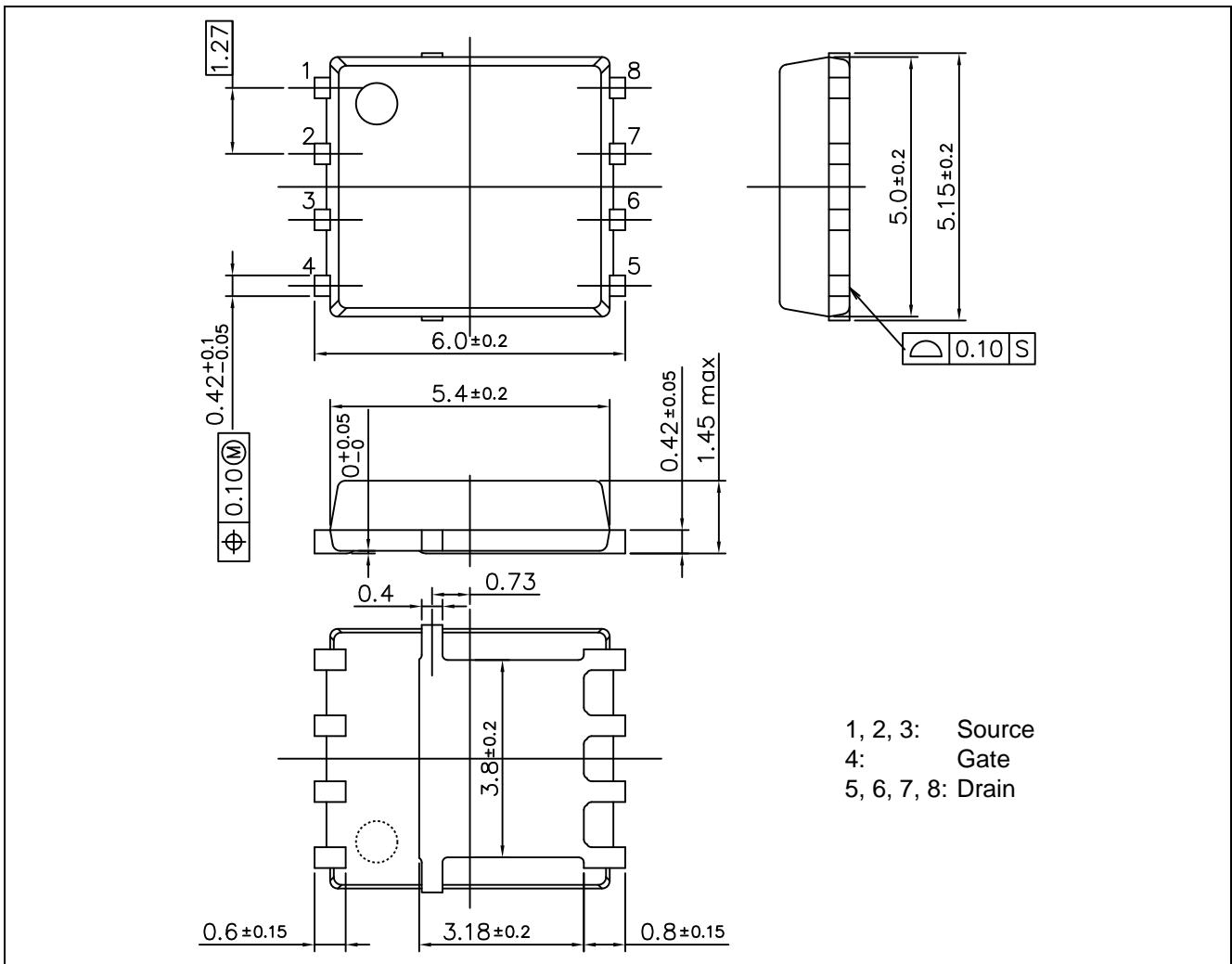


REVERSE RECOVERY TIME vs. DRAIN CURRENT

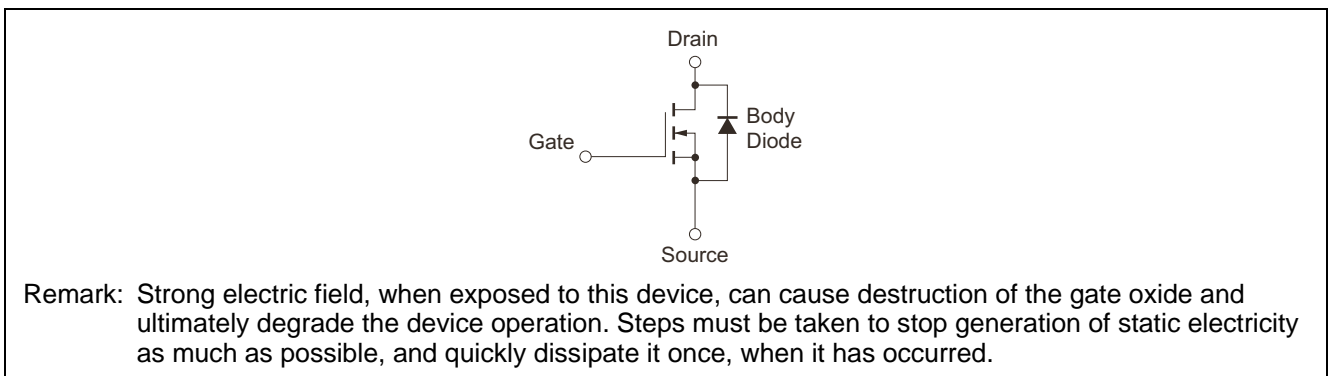


Package Drawings (Unit: mm)

8-pin HSON (Mass: 0.13 g TYP.)



Equivalent Circuit



Revision History	NP20N10YDF Data Sheet
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Rev.	Date	Description	
		Page	Summary
1.00	Apr 17, 2012	—	First Edition Issued

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